

### TRANSMITTAL LETTER (General - Patent Pending)

Docket No. END920010115US2

Darbha et al.

Serial No.	
10/629,469	

Filing Date 7/29/03

Examiner

**Group Art Unit** 

Nguyen, Dilinh P.

2814

Title: STRESS REDUCTION IN FLIP-CHIP PBGA PACKAGING BY UTILIZING SEGMENTED CHIPS AND/OR CHIP CARRIERS

#### TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Amendment (10 pages)

Figure 7 (1 page)

in the above identified application.

- No additional fee is required.
- A check in the amount of

is attached.

The Director is hereby authorized to charge and credit Deposit Account No.

09-0457(IBM)

as described below.

- Charge the amount of
- X Credit any overpayment.
- X Charge any additional fee required.

Jack P. Fredna Signature

Dated: 3/31/2004

Jack P. Friedman Reg. No. 44,688

Schmeiser, Olsen & Watts 3 Lear Jet Lane, Suite 201 Latham, NY 12110 (518) 220-1850

22313-1450.

with the U.S. Postal Service as on 3/31/2004 first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA

I certify that this document and fee is being deposited

Signature of Person Mailing Correspondence

Kim Dwileski

Typed or Printed Name of Person Mailing Correspondence



# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Darbha et al.

Art Unit: 2814

Serial No.: 10/629,469

Dkt. No.: END920010115US2

Filed: 7/29/2003

Examiner: Nguyen, Dilinh P.

Title: STRESS REDUCTION IN FLIP-CHIP PBGA PACKAGING BY UTILIZING SEGMENTED CHIPS AND/OR CHIP CARRIERS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

#### **AMENDMENT**

Sir:

In response to the Office Action mailed February 3, 2004, please amend the aboveidentified application as follows:

# In the Drawings

Please revise the drawings in accordance with the Request for Approval of Drawing Corrections attached hereto.